

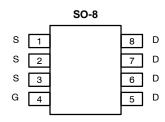


# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$r_{DS(on)}(\Omega)$	I <sub>D</sub> (A)			
30	0.024 @ V <sub>GS</sub> = 10 V	8.1			
	0.033 @ V <sub>GS</sub> = 4.5 V	6.9			

### **FEATURES**

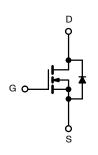
• TrenchFET® Power MOSFETS



Top View

Ordering Information: Si9410BDY

SI9410BDY Si9410BDY-T1 (with Tape and Reel) Si9410BDY—E3 (Lead (Pb)-Free) Si9410BDY-T1—E3 (Lead (Pb)-Free with Tape and Reel)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C UNLESS OTHERWISE NOTED)							
Parameter		Symbol	10 secs	Steady State	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30		٧		
Gate-Source Voltage		V <sub>GS</sub>	±20				
O-atimized David Oranget II. 1500008	T <sub>A</sub> = 25°C	- I <sub>D</sub>	8.1	6.2			
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 70°C		6.5	5.0			
Pulsed Drain Current (10 μs Pulse Width)		I <sub>DM</sub>	30		Α		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.1	1.2			
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C		2.5	1.5	14/		
	T <sub>A</sub> = 70°C	P <sub>D</sub> -	1.6	0.9	W		
Operating Junction and Storage Temperature Range	•	T <sub>J</sub> , T <sub>stg</sub>	-55	to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	P R <sub>thJA</sub> 70	40	50	°C/W	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		70	85		
Maximum Junction-to-Foot	Steady State		20	24		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

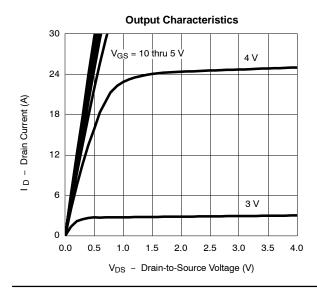
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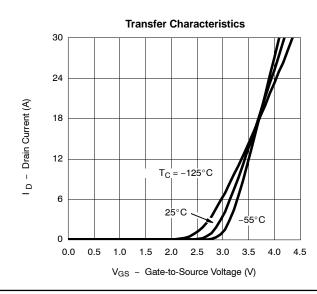


Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
	<b>- - - - - - - - - -</b>			- 7 P	1	0
Static	<u> </u>					1
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.0		3.0	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$		5	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8.1 A		0.019 0.024		Ω
Drain-Gource On-Glate Hesistance		$V_{GS} = 4.5 \text{ V}, I_D = 6.9 \text{ A}$		0.026	0.033	34
Forward Transconductancea	9fs	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8.1 A		20		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 2.1 A, V <sub>GS</sub> = 0 V		0.8	1.2	V
Dynamic <sup>b</sup>						
Total Gate Charge	Qg			15	23	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_D$ = 8.1 A		3.2		nC
Gate-Drain Charge	Q <sub>gd</sub>			2.5		
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		15	25	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1\overline{A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		30	45	
Fall Time	t <sub>f</sub>			11	20	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.1 A, di/dt = 100 A/μs		25	50	1

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





Notes a. Pulse test; pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%$ . b. Guaranteed by design, not subject to production testing.

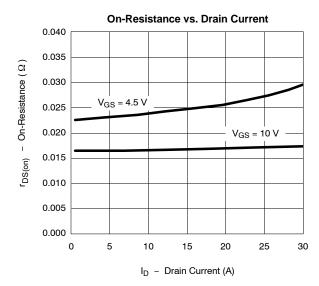


V<sub>GS</sub> - Gate-to-Source Voltage (V)

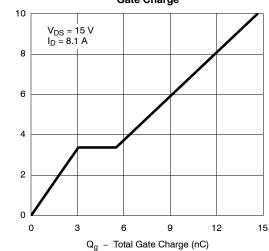
Source Current (A)

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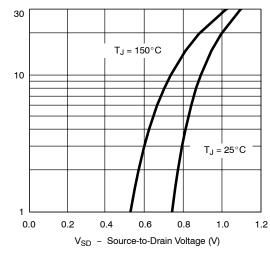
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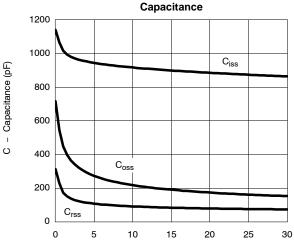






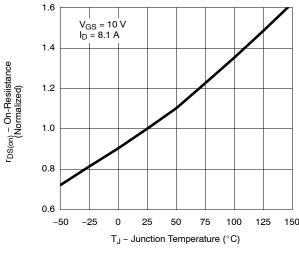
### Source-Drain Diode Forward Voltage



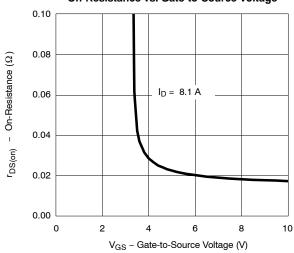


V<sub>DS</sub> - Drain-to-Source Voltage (V)

### On-Resistance vs. Junction Temperature



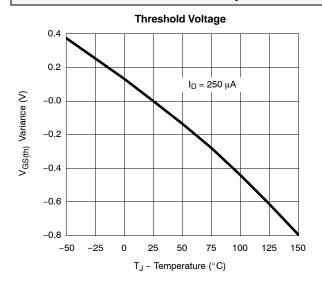
## On-Resistance vs. Gate-to-Source Voltage

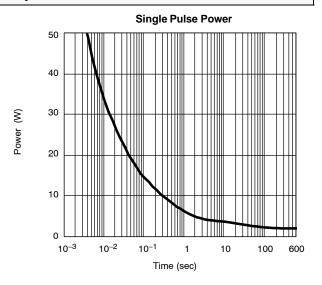


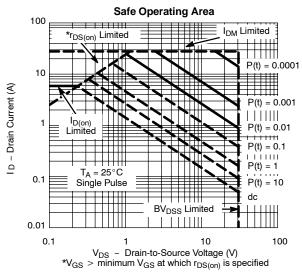
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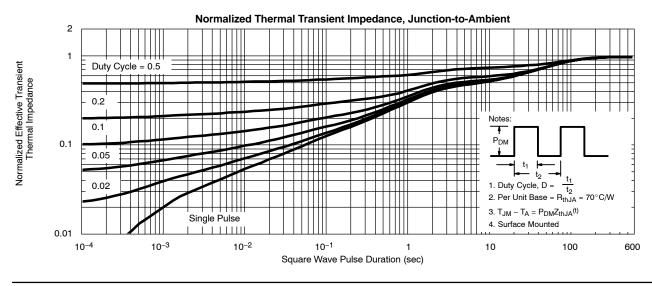


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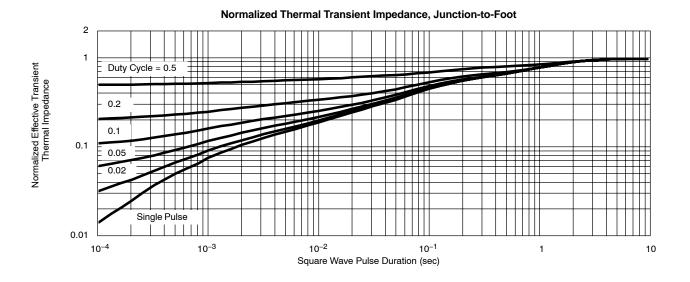






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## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?77269">http://www.vishay.com/ppg?77269</a>.



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